PKU 4000E series Direct Converters
Input 36 - 72 V, Output up to 10 A / 33 W

Key Features
- Industry standard Sixteenth-brick
  33.02 x 22.86 x 7.50 mm (1.3 x 0.9 x 0.295 in.)
- Input range 36-72 Vin
- High efficiency, typ. 88.1% at 3.3 V full load
- 1500 Vdc input to output isolation
- Surface mount option only
- Meets safety requirements according to IEC/EN/UL 60950
- More than 1.71 million hours MTBF

General Characteristics
- Output over voltage protection
- Input under voltage protection
- Over temperature protection
- Output short-circuit protection
- Remote control
- Highly automated manufacturing ensures quality
- ISO 9001/14001 certified supplier

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PKU 4310E SI (PKU 4000E series) Direct Converters
Input 36 - 72 V, Output up to 10 A / 33 W

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Technical Specification
Ordering Information

<table>
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<tr>
<th>Product program</th>
<th>Output</th>
</tr>
</thead>
<tbody>
<tr>
<td>PKU 4310E</td>
<td>3.3 V, 10 A / 33 W</td>
</tr>
</tbody>
</table>

Product number and Packaging

<table>
<thead>
<tr>
<th>Options</th>
<th>n1</th>
<th>n2</th>
<th>n3</th>
<th>n4</th>
</tr>
</thead>
<tbody>
<tr>
<td>Mounting</td>
<td>o</td>
<td></td>
<td></td>
<td>o</td>
</tr>
<tr>
<td>Remote Control logic</td>
<td>o</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Mechanical option</td>
<td>o</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Delivery package information</td>
<td>o</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Example a surface mount, positive logic with tray packaging would be PKU 4310E S/P/B.

* Standard variant (i.e. no option selected).
** only with Tape and Reel package.

General Information

Reliability

The Mean Time Between Failure (MTBF) is calculated at full output power and an operating ambient temperature (Ta) of +40°C, which is a typical condition in Information and Communication Technology (ICT) equipment. Different methods could be used to calculate the predicted MTBF and failure rate which may give different results. Flex currently uses Telcordia SR332.

Predicted MTBF for the series is:

- 1.71 million hours according to Telcordia SR332, issue 1, Black box technique.

The Flex failure rate data system is based on field tracking data. The data corresponds to actual failure rates of components used in ICT equipment in temperature controlled environments (Ta = -5...+65°C). Telcordia SR332 is a commonly used standard method intended for reliability calculations in ICT equipment. The parts count procedure used in this method was originally modelled on the methods from MIL-HDBK-217F, Reliability Predictions of Electronic Equipment. It assumes that no reliability data is available on the actual units and devices for which the predictions are to be made, i.e. all predictions are based on generic reliability parameters.

Compatibility with RoHS requirements

The products are compatible with the relevant clauses and requirements of the RoHS directive 2002/95/EC and have a maximum concentration value of 0.1% by weight in homogeneous materials for lead, mercury, hexavalent chromium, PBB and PBDE and of 0.01% by weight in homogeneous materials for cadmium.

Exemptions in the RoHS directive utilized in Flex products include:

- Lead in high melting temperature type solder (used to solder the die in semiconductor packages)
- Lead in glass of electronics components and in electronic ceramic parts (e.g. fill material in chip resistors)
- Lead as an alloying element in copper alloy containing up to 4% lead by weight (used in connection pins made of Brass)

Quality Statement

The products are designed and manufactured in an industrial environment where quality systems and methods like ISO 9000, 6σ (sigma), and SPC are intensively in use to boost the continuous improvements strategy. Infant mortality or early failures in the products are screened out and they are subjected to an ATE-based final test. Conservative design rules, design reviews and product qualifications, plus the high competence of an engaged work force, contribute to the high quality of our products.

Warranty

Warranty period and conditions are defined in Flex General Terms and Conditions of Sale.

Limitation of Liability

Flex does not make any other warranties, expressed or implied including any warranty of merchantability or fitness for a particular purpose (including, but not limited to, use in life support applications, where malfunctions of product can cause injury to a person's health or life).

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PKU 4000E series Direct Converters
Input 36 - 72 V, Output up to 10 A / 33 W

Safety Specification

General information
Flex DC/DC converters and DC/DC regulators are designed in accordance with safety standards IEC/EN/UL60950, Safety of Information Technology Equipment.

IEC/EN/UL60950 contains requirements to prevent injury or damage due to the following hazards:

- Electrical shock
- Energy hazards
- Fire
- Mechanical and heat hazards
- Radiation hazards
- Chemical hazards

On-board DC-DC converters and DC/DC regulators are designed as component power supplies. As components they cannot fully comply with the provisions of any Safety requirements without “Conditions of Acceptability”. Clearance between conductors and between conductive parts of the component power supply and conductors on the board in the final product must meet the applicable Safety requirements. Certain conditions of acceptability apply for component power supplies with limited stand-off (see Mechanical Information for further information). It is the responsibility of the installer to ensure that the final product housing these components complies with the requirements of all applicable Safety standards and Directives for the final product.

Component power supplies for general use should comply with the requirements in IEC60950, EN60950 and UL60950 "Safety of information technology equipment". There are other more product related standards, e.g. IEEE802.3af "Ethernet LAN/MAN Data terminal equipment power", and ETS300132-2 "Power supply interface at the input to telecommunications equipment; part 2: DC", but all of these standards are based on IEC/EN/UL60950 with regards to safety.

Flex DC/DC converters and DC/DC regulators are UL60950 recognized and certified in accordance with EN60950.

The flammability rating for all construction parts of the products meets requirements for V-0 class material according to IEC 60695-11-10.

The products should be installed in the end-use equipment, in accordance with the requirements of the ultimate application. Normally the output of the DC/DC converter is considered as SELV (Safety Extra Low Voltage) and the input source must be isolated by minimum Double or Reinforced Insulation from the primary circuit (AC mains) in accordance with IEC/EN/UL60950.

Isolated DC/DC converters

It is recommended that a slow blow fuse with a rating twice the maximum input current per selected product be used at the input of each DC/DC converter. If an input filter is used in the circuit the fuse should be placed in front of the input filter.

In the rare event of a component problem in the input filter or in the DC/DC converter that imposes a short circuit on the input source, this fuse will provide the following functions:

- Isolate the faulty DC/DC converter from the input power source so as not to affect the operation of other parts of the system.
- Protect the distribution wiring from excessive current and power loss thus preventing hazardous overheating.

The galvanic isolation is verified in an electric strength test. The test voltage (Viso) between input and output is 1500 Vdc or 2250 Vdc for 60 seconds (refer to product specification).

Leakage current is less than 1 µA at nominal input voltage.

24 V DC systems

The input voltage to the DC/DC converter is SELV (Safety Extra Low Voltage) and the output remains SELV under normal and abnormal operating conditions.

48 and 60 V DC systems

If the input voltage to the DC/DC converter is 75 Vdc or less, then the output remains SELV (Safety Extra Low Voltage) under normal and abnormal operating conditions.

Single fault testing in the input power supply circuit should be performed with the DC/DC converter connected to demonstrate that the input voltage does not exceed 75 Vdc.

If the input power source circuit is a DC power system, the source may be treated as a TNV2 circuit and testing has demonstrated compliance with SELV limits and isolation requirements equivalent to Basic Insulation in accordance with IEC/EN/UL60950.

Non-isolated DC/DC regulators

The input voltage to the DC/DC regulator is SELV (Safety Extra Low Voltage) and the output remains SELV under normal and abnormal operating conditions.
**Absolute Maximum Ratings**

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>min</th>
<th>typ</th>
<th>max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$T_{PT}$ Operating Temperature (see Thermal Consideration section)</td>
<td>-40</td>
<td></td>
<td>+105</td>
<td>°C</td>
</tr>
<tr>
<td>$T_S$ Storage temperature</td>
<td>-55</td>
<td></td>
<td>+100</td>
<td>°C</td>
</tr>
<tr>
<td>$V_i$ Input voltage</td>
<td>-0.5</td>
<td>80</td>
<td>+80</td>
<td>V</td>
</tr>
<tr>
<td>$V_{iso}$ Isolation voltage (input to output test voltage)</td>
<td></td>
<td></td>
<td>1500</td>
<td>Vdc</td>
</tr>
<tr>
<td>$V_{tr}$ Input voltage transient ($t_p$ 100 ms)</td>
<td></td>
<td>100</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>$V_{RC}$ Remote Control pin voltage</td>
<td>-0.5</td>
<td>40</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>(see Operating Information section)</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Positive logic option</td>
<td>-0.5</td>
<td>40</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Negative logic option</td>
<td>-0.5</td>
<td>2x$V_{oi}$</td>
<td></td>
<td>V</td>
</tr>
</tbody>
</table>

Stress in excess of Absolute Maximum Ratings may cause permanent damage. Absolute Maximum Ratings, sometimes referred to as no destruction limits, are normally tested with one parameter at a time exceeding the limits of Output data or Electrical Characteristics. If exposed to stress above these limits, function and performance may degrade in an unspecified manner.

**Fundamental Circuit Diagram**
### 3.3 V/10 A Electrical Specification

**PKU 4310E SI**

*T_P1 = -30 to +90°C, V_I = 36 to 72 V, unless otherwise specified under Conditions.
Typical values given at: T_P1 = +25°C, V_I = 53 V, max I_O, unless otherwise specified under Conditions.
Additional C_out = 220 µF.*

#### Characteristics

<table>
<thead>
<tr>
<th>Conditions</th>
<th>min</th>
<th>typ</th>
<th>max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>V_I</td>
<td>Input voltage range</td>
<td>36</td>
<td>72</td>
<td>V</td>
</tr>
<tr>
<td>V_off</td>
<td>Turn-off input voltage</td>
<td>31.5</td>
<td>32.5</td>
<td>33.5</td>
</tr>
<tr>
<td>V_on</td>
<td>Turn-on input voltage</td>
<td>33.5</td>
<td>34.5</td>
<td>35.5</td>
</tr>
<tr>
<td>C_i</td>
<td>Internal input capacitance</td>
<td>4.4</td>
<td></td>
<td>µF</td>
</tr>
<tr>
<td>P_O</td>
<td>Output power</td>
<td>0</td>
<td>33</td>
<td>W</td>
</tr>
<tr>
<td>η</td>
<td>Efficiency</td>
<td>50 % of max I_O, V_I = 36 V</td>
<td>89.4</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>max I_O, V_I = 36 V</td>
<td>89.2</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>50 % of max I_O, V_I = 53 V</td>
<td>87.3</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>max I_O, V_I = 53 V</td>
<td>88.1</td>
<td></td>
</tr>
<tr>
<td>P_R</td>
<td>Power Dissipation</td>
<td>max I_O</td>
<td>4.4</td>
<td>7.5</td>
</tr>
<tr>
<td>P_id</td>
<td>Input idling power</td>
<td>I_O = 0 A, V_I = 53 V</td>
<td>1.8</td>
<td></td>
</tr>
<tr>
<td>P_RC</td>
<td>Input standby power</td>
<td>V_I = 53 V (turned off with RC)</td>
<td>0.65</td>
<td></td>
</tr>
<tr>
<td>f_s</td>
<td>Switching frequency</td>
<td>0-100 % of max I_O</td>
<td>270</td>
<td>285</td>
</tr>
</tbody>
</table>

#### PKU 4000E series Direct Converters

**Input 36 - 72 V, Output up to 10 A / 33 W**

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**Technical Specification**

EN/LZT 146 425 R3B May 2018
### 3.3 V/10 A Typical Characteristics

#### Efficiency

- **Efficiency vs. load current and input voltage at \( T_{PI} = +25 \text{°C} \)**

#### Power Dissipation

- **Dissipated power vs. load current and input voltage at \( T_{PI} = +25 \text{°C} \)**

#### Output Characteristics

- **Output voltage vs. load current at \( T_{PI} = +25 \text{°C} \)**

#### Current Limit Characteristics

- **Output voltage vs. load current at \( I_O > \text{max } I_O \), \( T_{PI} = +25 \text{°C} \)**
  - The module enters hiccup mode when the output current exceeds current limit.

#### Output Current Derating

- **Available load current vs. ambient air temperature and airflow at \( V_I = 53 \text{ V} \). See Thermal Consideration section.**
3.3 V/10 A Typical Characteristics

**Start-up**

Start-up enabled by connecting $V_i$ at:
- $T_{D1} = +25^\circ C$, $V_i = 53 V$
- $I_o = 10$ A resistive load.

Top trace: output voltage (1 V/div.).
Bottom trace: input voltage (20 V/div.).
Time scale: (2 ms/div.).

**Shut-down**

Shut-down enabled by disconnecting $V_i$ at:
- $T_{D1} = +25^\circ C$, $V_i = 53 V$
- $I_o = 10$ A resistive load.

Top trace: output voltage (1 V/div.).
Bottom trace: input voltage (50 V/div.).
Time scale: (0.5 ms/div.).

**Output Ripple & Noise**

Output voltage ripple at:
- $T_{D1} = +25^\circ C$, $V_i = 53 V$
- $I_o = 10$ A resistive load.

Trace: output voltage (20 mV/div.).
Time scale: (2 µs/div.).

**Output Load Transient Response**

Output voltage response to load current step-change (2.5-7.5-2.5 A) at:
- $T_{D1} = +25^\circ C$, $V_i = 53 V$.

Top trace: output voltage (200 mV/div.).
Bottom trace: load current (5 A/div.).
Time scale: (0.5 ms/div.).

**Output Voltage Adjust (see operating information)**

**Passive adjust**
The resistor value for an adjusted output voltage is calculated by using the following equations:

\[
R_{adj} = \left( \frac{-5.11 \times 3.30(100 + \Delta \%)}{1.225 \times \Delta} \right) \frac{511}{\Delta \%} - 10.22 \, k\Omega
\]

Example: Increase 4\% \(\Rightarrow V_{out} = 3.432\, V_{dc}\)

\[
R_{adj} = \left( \frac{-5.11 \times 3.30(100 + 4)}{1.225 \times 4} \right) \frac{511}{4} - 10.22 \, k\Omega = 220 \, k\Omega
\]

**Active adjust**
The output voltage may be adjusted using a voltage applied to the $V_{adj}$ pin. This voltage is calculated by using the following equations:

\[
V_{adj} = \left( 1.225 + 2.45 \times \frac{V_{desired} - 3.30}{3.30} \right) V
\]

Example: Upwards \(\Rightarrow 3.50\, V\)

\[
V_{adj} = \left( 1.225 + 2.45 \times \frac{3.50 - 3.30}{3.30} \right) V = 1.37\, V
\]
PKU 4000E series Direct Converters
Input 36 - 72 V, Output up to 10 A / 33 W

EMC Specification
Conducted EMI measured according to EN55022, CISPR 22 and FCC part 15J (see test set-up). See Design Note 009 for further information. The fundamental switching frequency is 285 kHz for PKU 4310E SI.

Conducted EMI Input terminal value (typ)

[Graph showing conducted EMI levels]

EMI without filter @ \( V_i = 53 \, V \), max \( I_o \).

External filter (class B)
Required external input filter in order to meet class B in EN 55022, CISPR 22 and FCC part 15J.

Filter components:
- \( C_1,2 = 2.2 \, \mu F \)
- \( C_3 = 100 \, \mu F \)
- \( C_5,6 = 10 \, nF, 2kV \)
- \( L_1 = 1.47mH \)

EMI with filter @ \( V_i = 53 \, V \), max \( I_o \).

Layout recommendations
The radiated EMI performance of the Product will depend on the PCB layout and ground layer design. It is also important to consider the stand-off of the product. If a ground layer is used, it should be connected to the output of the product and the equipment ground or chassis.

A ground layer will increase the stray capacitance in the PCB and improve the high frequency EMC performance.

Output ripple and noise
Output ripple and noise measured according to figure below. See Design Note 022 for detailed information.
Operating information

Input Voltage
The input voltage range 36 to 72Vdc meets the requirements of the European Telecom Standard ETS 300 132-2 for normal input voltage range in –48 and –60 Vdc systems, -40.5 to -57.0 V and –50.0 to -72 V respectively.

At input voltages exceeding 72 V, the power loss will be higher than at normal input voltage. Precaution must be taken to keep $T_{P1}$ below +95°C. The absolute maximum continuous input voltage is 80 Vdc.

Turn-off Input Voltage
The products monitor the input voltage and will turn on and turn off at predetermined levels. The minimum hysteresis between turn on and turn off input voltage is 2V. The input voltage supply must have low impedance to prevent the risk of input oscillation, poor supply can also cause shutdown-bouncing.

Remote Control (RC)
The products are fitted with a remote control function referenced to the primary negative input connection (-In), with negative and positive logic options available. The RC function allows the product to be turned on/off by an external device like a semiconductor or mechanical switch. The RC pin has an internal pull up resistor to +In.

The maximum required sink current is 1 mA. When the RC pin is left open, the voltage generated on the RC pin is 4.5 – 5.5 V.

The standard product is provided with “negative logic” remote control and will be off until the RC pin is connected to the -In. To turn on the product the voltage between RC pin and -In should be less than 1V.

To turn off the converter the RC pin should be left open, or connected to a voltage higher than 4 V referenced to -In. In situations where it is desired to have the product to power up automatically without the need for control signals or a switch, the RC pin can be wired directly to -In.

The second option is “positive logic” remote control, which can be ordered by adding the suffix “P” to the end of the part number.
When the RC pin is left open, the product starts up automatically when the input voltage is applied. Turn off is achieved by connecting the RC pin to the -In. To ensure safe turn off the voltage difference between RC pin and the -In pin shall be less than 1V. The product will restart automatically when this connection is opened.

See Design Note 021 for detailed information.

Input and Output Impedance
The impedance of both the input source and the load will interact with the impedance of the DC/DC converter. It is important that the input source has low characteristic impedance.

The performance in some applications can be enhanced by addition of external capacitance as described in External Decoupling Capacitors.

If the input voltage source contains significant inductance, the addition of a low ESR 33 µF capacitor across the input of the converter will ensure stable operation in all conditions.

External Decoupling Capacitors
The products have been designed to operate with a minimum capacitance connected to their output.

When powering loads with significant dynamic current requirements, the voltage regulation at the point of load can be improved by addition of decoupling capacitors at the load. The most effective technique is to locate low ESR ceramic and electrolytic capacitors as close to the load as possible, using several parallel capacitors to lower the effective ESR. The ceramic capacitors will handle high-frequency dynamic load changes while the electrolytic capacitors are used to handle low frequency dynamic load changes. Ceramic capacitors will also reduce any high frequency noise at the load.

It is equally important to use low resistance and low inductance PCB layouts and cabling. If significant inductance are within the load distribution, >50% of the stated “Minimum Output Capacitance” shall be located at the module’s output.

External decoupling capacitors will become part of the control loop of the DC/DC converter and may affect the stability margins. As a “rule of thumb”, 100 µF/A of output current can be added without any additional analysis. The ESR of the capacitors is a very important parameter.

Flex Power Modules guarantee stable operation with a verified ESR value of >10 mΩ across the output connections.

<table>
<thead>
<tr>
<th>Minimum Input Capacitance</th>
<th>Minimum Output Capacitance</th>
</tr>
</thead>
<tbody>
<tr>
<td>PKU 4310E SI 33µF</td>
<td>220µF</td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
<tr>
<td>Minimum capacitance</td>
<td></td>
</tr>
</tbody>
</table>

For further information please contact your local Flex Power Modules representative.
Operating information continued

Output Voltage Adjust (V_adj)
The products have an Output Voltage Adjust pin (V_adj). This pin can be used to adjust the output voltage above or below Output voltage initial setting.

When increasing the output voltage, the voltage at the output pins must be kept below the threshold of the over voltage protection, (OVP) to prevent the product from entering OVP. At increased output voltages the maximum power rating of the product remains the same, and the max output current must be decreased correspondingly.

To increase the voltage the resistor should be connected between the V_adj pin and +Out pin. The resistor value of the Output voltage adjust function is according to information given under the Output section for the respective product.

To decrease the output voltage, the resistor should be connected between the V_adj pin and –Out pin.

Over Temperature Protection (OTP)
The converters are protected from thermal overload by an internal over temperature shutdown circuit.

When \( T_{P1} \) as defined in thermal consideration section reaches exceeds 105°C the converter will shut down.

The DC/DC converter will make continuous attempts to start up (non-latching mode) and resume normal operation automatically when the hot-spot temperature has dropped 10°C below the temperature threshold.

Over Voltage Protection (OVP)
The converters have output over voltage protection that will prevent output voltage to exceed the specified value in technical specification.

The converter will limit the output voltage to the maximum level. Converters will resume normal operation automatically after removal of the over voltage condition.

Over Current Protection (OCP)
The converters include current limiting circuitry for protection at continuous overload.

The output voltage will decrease towards zero for output currents in excess of max output current (max \( I_0 \)).

After a time period exceeding 10 ms in OCP converters will enter hiccup mode to reduce average output power.

During short-circuit condition module temperature will increase rapidly and OTP function may be activated.

Module will not resume from hiccup shutdown period unless the temperature drops below the OTP re-activation temperature.

The converter will resume normal operation after removal of the overload. The load distribution should be designed for the maximum output short circuit current specified.

Pre-bias Start-up
The product has a Pre-bias start up functionality and will not sink current during start up or RC-off if a pre-bias source with less than 75% of \( V_o \) is present at the output terminals.

Precaution must be taken that reverse current might be present if \( V_i \) is disabled. Without \( V_i \) a small current will discharge external capacitors.

Feeding \( V_o \) from external power supply for test purpose might without \( V_i \) cause high reverse current.
Thermal Consideration

General
The products are designed to operate in different thermal environments and sufficient cooling must be provided to ensure reliable operation.

For products mounted on a PCB without a heat sink attached, cooling is achieved mainly by conduction, from the pins to the host board, and convection, which is dependant on the airflow across the product. Increased airflow enhances the cooling of the product. The Output Current Derating graph found in the Output section for each model provides the available output current vs. ambient air temperature and air velocity at $V_{I} = 53 \, \text{V}$.

The product is tested on a 254 x 254 mm, 35 µm (1 oz), 8-layer test board mounted vertically in a wind tunnel with a cross-section of 608 x 203 mm.

Proper cooling of the product can be verified by measuring the temperature at position P1. The temperature at this position should not exceed the max values provided in the table below. The number of points may vary with different thermal design and topology.

See Design Note 019 for further information.

<table>
<thead>
<tr>
<th>Position</th>
<th>Description</th>
<th>Temp. limit</th>
</tr>
</thead>
<tbody>
<tr>
<td>P1</td>
<td>Opto coupler</td>
<td>95º C</td>
</tr>
</tbody>
</table>

Definition of reference temperature $T_{P1}$
The reference temperature is used to monitor the temperature limits of the product. Temperatures above maximum $T_{P1}$, measured at the reference point P1 are not allowed and may cause degradation or permanent damage to the product. $T_{P1}$ is also used to define the temperature range for normal operating conditions. $T_{P1}$ is defined by the design and used to guarantee safety margins, proper operation and high reliability of the product.

Connections

<table>
<thead>
<tr>
<th>Pin</th>
<th>Designation</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>+In</td>
<td>Positive Input</td>
</tr>
<tr>
<td>2</td>
<td>RC</td>
<td>Remote control</td>
</tr>
<tr>
<td>3</td>
<td>-In</td>
<td>Negative Input</td>
</tr>
<tr>
<td>4</td>
<td>-Out</td>
<td>Negative Output</td>
</tr>
<tr>
<td>6</td>
<td>Vadj</td>
<td>Output voltage adjust</td>
</tr>
<tr>
<td>8</td>
<td>+Out</td>
<td>Positive Output</td>
</tr>
</tbody>
</table>
PKU 4000E series Direct Converters
Input 36 - 72 V, Output up to 10 A / 33 W

Technical Specification

Mechanical Information - Surface Mount Version

Pin positions according to the recommended footprint
33.0 x 4.0
9.5 x 1.0

Pin-up nozzle
max Ø7 [0.28]

Recommended footprint - Top View
39.2 x 39.2

Recommended keep away area for user components

All component placements – whether shown as physical components or symbolical outline – are for reference only and are subject to change throughout the product’s life cycle, unless explicitly described and dimensioned in this drawing.
Mechanical Information - Surface Mount Version M option

Product height 8.7 [mm]
[0.343 [in.]]

Component outline

Standoff 2.7 [mm]
[0.1063 [in.]]

Pin positions according to the recommended footprint

33.02 ± 0.5
[1.30 ± 0.020]

Recommended footprint - top view

34.04
[1.34]

All component placements – whether shown as physical components or symbolical outline – are for reference only and are subject to change throughout the product’s life cycle, unless explicitly described and dimensioned in this drawing.
Soldering Information - Surface Mounting

The surface mount product is intended for forced convection or vapor phase reflow soldering in SnPb or Pb-free processes.

The reflow profile should be optimised to avoid excessive heating of the product. It is recommended to have a sufficiently extended preheat time to ensure an even temperature across the host PWB and it is also recommended to minimize the time in reflow.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board, since cleaning residues may affect long time reliability and isolation voltage.

General reflow process specifications

<table>
<thead>
<tr>
<th></th>
<th>SnPb eutectic</th>
<th>Pb-free</th>
</tr>
</thead>
<tbody>
<tr>
<td>Average ramp-up (TPRODUCT)</td>
<td>3°C/s max</td>
<td>3°C/s max</td>
</tr>
<tr>
<td>Typical solder melting (liquidus) temperature (TL)</td>
<td>183°C</td>
<td>221°C</td>
</tr>
<tr>
<td>Minimum reflow time above TL</td>
<td>30 s</td>
<td>30 s</td>
</tr>
<tr>
<td>Minimum pin temperature (TPIN)</td>
<td>210°C</td>
<td>235°C</td>
</tr>
<tr>
<td>Peak product temperature (TPRODUCT)</td>
<td>225°C</td>
<td>260°C</td>
</tr>
<tr>
<td>Average ramp-down (TPRODUCT)</td>
<td>6°C/s max</td>
<td>6°C/s max</td>
</tr>
<tr>
<td>Maximum time 25°C to peak</td>
<td>6 minutes</td>
<td>8 minutes</td>
</tr>
</tbody>
</table>

Minimum Pin Temperature Recommendations

Pin number 8 is chosen as reference location for the minimum pin temperature recommendation since this will likely be the coolest solder joint during the reflow process.

SnPb solder processes

For SnPb solder processes, a pin temperature (TPIN) in excess of the solder melting temperature (TL, 183°C for Sn63Pb37) for more than 30 seconds and a peak temperature of 210°C is recommended to ensure a reliable solder joint.

For dry packed products only: depending on the type of solder paste and flux system used on the host board, up to a recommended maximum temperature of 245°C could be used, if the products are kept in a controlled environment (dry pack handling and storage) prior to assembly.

Lead-free (Pb-free) solder processes

For Pb-free solder processes, a pin temperature (TPIN) in excess of the solder melting temperature (TL, 217 to 221°C for SnAgCu solder alloys) for more than 30 seconds and a peak temperature of 235°C on all solder joints is recommended to ensure a reliable solder joint.

Maximum Product Temperature Requirements

Top of the product PWB near pin 2 is chosen as reference location for the maximum (peak) allowed product temperature (TPRODUCT) since this will likely be the warmest part of the product during the reflow process.

SnPb solder processes

For SnPb solder processes, the product is qualified for MSL 1 according to IPC/JEDEC standard J-STD-020C.

During reflow TPRODUCT must not exceed 225 °C at any time.

Pb-free solder processes

For Pb-free solder processes, the product is qualified for MSL 3 according to IPC/JEDEC standard J-STD-020C.

During reflow TPRODUCT must not exceed 260 °C at any time.

Dry Pack Information

Products intended for Pb-free reflow soldering processes are delivered in standard moisture barrier bags according to IPC/JEDEC standard J-STD-033 (Handling, packing, shipping and use of moisture/reflow sensitivity surface mount devices).

Using products in high temperature Pb-free soldering processes requires dry pack storage and handling. In case the products have been stored in an uncontrolled environment and no longer can be considered dry, the modules must be baked according to J-STD-033.
**Soldering Information - Hole Mounting**

The hole mounted product is intended for plated through hole mounting by wave or manual soldering. The pin temperature is specified to maximum to 270°C for maximum 10 seconds.

A maximum preheat rate of 4°C/s and maximum preheat temperature of 150°C is suggested. When soldering by hand, care should be taken to avoid direct contact between the hot soldering iron tip and the pins for more than a few seconds in order to prevent overheating.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board. The cleaning residues may affect long time reliability and isolation voltage.

**Delivery Package Information**

The surface mount products are delivered in antistatic injection molded trays (Jedec design guide 4.10D standard) and in antistatic carrier tape (EIA 481 standard).

The through-hole mount products are delivered in antistatic injection molded trays (Jedec design guide 4.10D standard).

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### Carrier Tape Specifications

<table>
<thead>
<tr>
<th>Material</th>
<th>Antistatic PS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Surface resistance</td>
<td>10^7 ≤ Ohm/square ≤ 10^12</td>
</tr>
<tr>
<td>Bakeability</td>
<td>The tape is not bakable</td>
</tr>
<tr>
<td>Tape width, W</td>
<td>56 mm [2.2 inch]</td>
</tr>
<tr>
<td>Pocket pitch, P</td>
<td>36 mm [1.42 inch]</td>
</tr>
<tr>
<td>Pocket depth, K</td>
<td>8.7 mm [0.343 inch]</td>
</tr>
<tr>
<td>Reel diameter</td>
<td>380 mm [15 inch]</td>
</tr>
<tr>
<td>Reel capacity</td>
<td>200 products /reel</td>
</tr>
<tr>
<td>Reel weight</td>
<td>2.3 kg/full reel</td>
</tr>
</tbody>
</table>

EIA standard carrier tape

- **Side view**
  - User tape feed direction
  - Pocket depth, K

- **Top view**
  - Tape width, W
  - Pin 1
  - Pocket pitch, P
  - Elongated holes

- **Pocket depth, K**

---

### Tray Specifications

<table>
<thead>
<tr>
<th>Material</th>
<th>Antistatic PPE</th>
</tr>
</thead>
<tbody>
<tr>
<td>Surface resistance</td>
<td>10^7 ≤ Ohm/square ≤ 10^12</td>
</tr>
<tr>
<td>Bakeability</td>
<td>The trays can be baked at maximum 125°C for 48 hours</td>
</tr>
<tr>
<td>Tray thickness</td>
<td>18.5 mm [0.728 inch]</td>
</tr>
<tr>
<td>Box capacity</td>
<td>30 products (1 full trays/box)</td>
</tr>
<tr>
<td>Tray weight</td>
<td>190 g empty, 500 g full tray</td>
</tr>
</tbody>
</table>

---

X = Vacuum pick up

All dimensions in mm [inch]

Tolerances: X ± 0.13 mm [0.005], X ± 0.26 mm [0.01]

Note: tray dimensions refer to pocket center. For exact location of product pick up surface, refer to mechanical drawing.
<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Specification</th>
<th>Temperature range</th>
<th>Number of cycles</th>
<th>Dwell/transfer time</th>
</tr>
</thead>
<tbody>
<tr>
<td>External visual inspection</td>
<td>IPC-A-610</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Change of temperature (Temperature cycling)</td>
<td>IEC 60068-2-14 Na</td>
<td>-40 to 100°C</td>
<td>1000</td>
<td>15 min/0-1 min</td>
</tr>
<tr>
<td>Cold (in operation)</td>
<td>IEC 60068-2-1 Ad</td>
<td>-45°C</td>
<td>72 h</td>
<td></td>
</tr>
<tr>
<td>Damp heat</td>
<td>IEC 60068-2-67 Cy</td>
<td>85°C</td>
<td>85 % RH</td>
<td>1000 hours</td>
</tr>
<tr>
<td>Dry heat</td>
<td>IEC 60068-2-2 Bd</td>
<td>125°C</td>
<td>1000 h</td>
<td></td>
</tr>
<tr>
<td>Electrostatic discharge susceptibility</td>
<td>IEC 61340-3-1, JESD 22-A114</td>
<td>Human body model (HBM)</td>
<td>Class 2, 2000 V</td>
<td>Class 3, 200 V</td>
</tr>
<tr>
<td>Immersion in cleaning solvents</td>
<td>IEC 60068-2-45XA, method 2</td>
<td>Water Glycol ether (Isopropyl alcohol)</td>
<td>55°C</td>
<td>35°C</td>
</tr>
<tr>
<td>Mechanical shock</td>
<td>IEC 60068-2-27 Ea</td>
<td>Peak acceleration</td>
<td>Duration</td>
<td>100 g</td>
</tr>
<tr>
<td>Moisture reflow sensitivity ¹</td>
<td>J-STD-020C</td>
<td>Level 1 (SnPb-eutectic)</td>
<td>225°C</td>
<td>260°C</td>
</tr>
<tr>
<td>Operational life test</td>
<td>MIL-STD-202G, method 108A</td>
<td>Level 3 (Pb Free)</td>
<td>Duration</td>
<td>1000 h</td>
</tr>
<tr>
<td>Resistance to soldering heat ²</td>
<td>IEC 60068-2-20 Tb, method 1A</td>
<td>Solder temperature</td>
<td>Duration</td>
<td>270°C</td>
</tr>
<tr>
<td>Robustness of terminations</td>
<td>IEC 60068-2-21 Test Ua1, IEC 60068-2-21 Test Ue1</td>
<td>Through hole mount products</td>
<td>All leads</td>
<td>All leads</td>
</tr>
<tr>
<td>Solderability</td>
<td>IEC 60068-2-58 test Td ¹</td>
<td>Preconditioning Temperature, SnPb Eutectic Temperature, Pb-free</td>
<td>150°C dry bake 16 h</td>
<td>215°C</td>
</tr>
<tr>
<td></td>
<td>IEC 60068-2-20 test Ta ²</td>
<td>Preconditioning Temperature, SnPb Eutectic Temperature, Pb-free</td>
<td>Steam ageing</td>
<td>233°C</td>
</tr>
<tr>
<td>Vibration, broad band random</td>
<td>IEC 60068-2-64 Fh, method 1</td>
<td>Frequency Spectral density</td>
<td>Duration</td>
<td>10 to 500 Hz</td>
</tr>
</tbody>
</table>

Notes

¹ Only for products intended for reflow soldering (surface mount products)
² Only for products intended for wave soldering (plated through hole products)